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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q78154

Kenichi OHKAWA, et al.

Appln. No.: 10/694,724

Group Art Unit: 1714

Confirmation No.: 4042

Examiner: Unknown

Filed: October 29, 2003

For: THERMOPLASTIC RESIN COMPOSITION AND ITS INJECTION MOLDED
ARTICLE

STATUS INQUIRY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The undersigned respectfully requests to be advised of the status of the above-identified application.

Respectfully submitted,

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Date: November 9, 2005